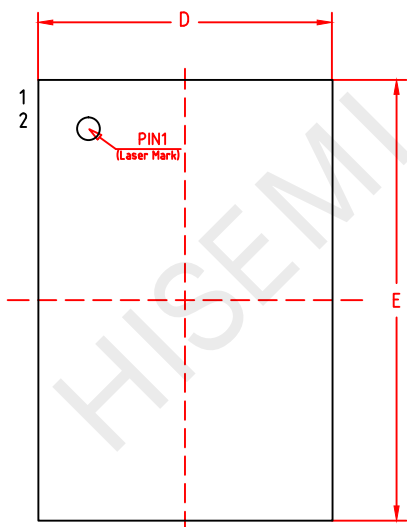


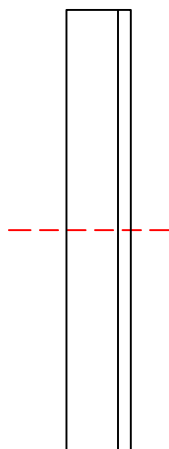
TOP VIEW

正视图



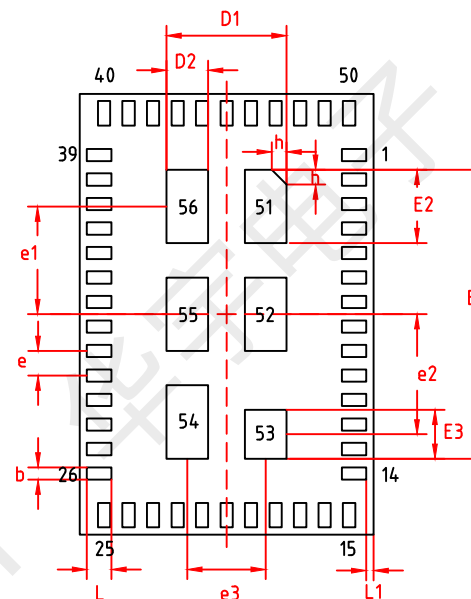
SIDE VIEW

侧视图



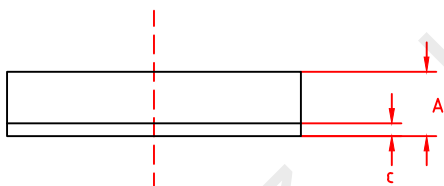
BOTTOM VIEW

背视图




SIDE VIEW

侧视图



机械尺寸/mm

字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	1.21	1.31	1.41
c	0.22	0.26	0.30
b	0.175	0.25	0.325
D	5.90	6.00	6.10
D1	2.35	2.45	2.55
D2	0.775	0.85	0.925
E	8.90	9.00	9.10
E1	5.80	5.90	6.00
E2	1.425	1.50	1.575
E3	0.925	1.00	1.075
e	0.50 BSC		
e1	2.20 BSC		
e2	2.45 BSC		
e3	1.60 BSC		
L	0.425	0.50	0.575
L1	0.075	0.15	0.225
h	0.25	0.30	0.35

 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD				制图: Draw	李家通 2021.09.16
图号 Drawing NO.	HY-POD-LGA560609001			制图核查: Drawing review	
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA56L (6×9×1.31-P0.5)			审核: Checker	
幅图 size	页数 page	单位 unit	比例 scale	视图 view	核准: Approved
A4	1	mm	1:1	